**Abstract:** A fundamentally new family of thermal spray processes has emerged. These new processes, collectively known as very low pressure plasma spray or VLPPS, differ from traditional thermal spray processes in that coatings are deposited at unusually low chamber pressures, typically less than ~800 Pa (6 Torr). Depending upon the specific process, deposition may be in the form of very fine molten droplets, vapor phase deposition, or a mixture of vapor and droplet deposition. Resulting coatings are similar in quality to coatings produced by alternative coating technologies, such as physical vapor deposition (PVD) or chemical vapor deposition (CVD), but deposition rates can be roughly an order of magnitude higher with VLPPS. With these new process technologies modified low pressure plasma spray (LPPS) systems can now be used to produce dense, high quality coatings in the 1 to 100 micron thickness range with lamellar or columnar microstructures. A history of pioneering work in VLPPS technology is presented, deposition mechanisms are discussed, potential new applications are reviewed, and challenges for the future are outlined.
Keywords: Very Low Pressure Plasma Spray (VLPPS); Plasma Spray-Thin Film (PS-TF); Vacuum Plasma Spray (VPS); Plasma Spray-Physical Vapor Deposition (PS-PVD); Plasma Spray-Chemical Vapor Deposition (PS-CVD); Low Pressure Plasma Spray Thin Film (LPPS-TF®); Low Pressure Plasma Spray (LPPS)

1. Introduction

The plasma spray process, invented circa 1940, remains one of the most versatile and widely used thermal spray processes. Over the years, process improvements have enhanced the quality and consistency of materials deposited with plasma spray, in conjunction with a continually expanding range of applications for plasma spray coatings. For example, wide-spread adoption of controlled atmosphere spraying in the 1980’s (commonly referred to as Low Pressure Plasma Spray—LPPS™ or Vacuum Plasma Spray—VPS™) greatly enhanced the quality of plasma sprayed metal coatings. This led to many new applications, such as coating critical turbine engine parts and medical implants. Advancements in process understanding and controls as well as improvements in plasma torch design have also contributed to improved coating quality and greater product uniformity. However, despite significant improvements over several decades, the basic process technology, i.e., heating of powder particles to spray-deposit molten or semi-molten droplets onto line-of-sight substrate surfaces, has remained essentially the same.

This review discusses some intriguing developments in plasma spray technology that offer the opportunity move beyond some of the traditional limitations of plasma spray technology and prepare coatings using fundamentally different deposition mechanisms. This new technology offers the capability to very rapidly deposit a wide range of materials, not just as molten droplets, but also from the vapor phase, using solid, liquid, and even gaseous feedstock. It also offers increased plasma velocity compared to traditional vacuum plasma spray. The resulting coatings are similar in many respects to coatings traditionally produced by physical vapor deposition (PVD) or chemical vapor deposition (CVD) processes. However, deposition rates are approximately an order of magnitude higher than traditional PVD and CVD processes, e.g., ~5 μm/minute compared to ~0.5 μm/minute. These new process technologies can produce dense (90% theoretical density) coatings with thicknesses on the order of 1 to 100 microns. Finally, unlike traditional plasma spray, this emerging process technology is not strictly limited to line-of-sight deposition.

This review begins with a brief discussion of a Low Pressure Plasma Spray system at Sandia National Laboratories, Albuquerque, NM, that was modified to achieve continuous operation at chamber pressures down to ~133 Pa (1 Torr). The properties of a plasma jet at very low pressures are then reviewed, followed by a discussion of various different process operating regimes and some resulting coating properties based on the limited data currently available. Finally, some brief comments are provided about potential applications of this new technology.
2. Origins of Very Low Pressure Plasma Spraying

In the mid 1990’s the late Eric Muehlberger, a creative pioneer in LPPS technology, began working with Sulzer Metco to explore new ways to rapidly and inexpensively apply very thin, highly uniform dielectric coatings over large surface areas (many square meters) of metal sheet. This led to a 1998 US Patent #5853815 entitled “Method of Forming Uniform Thin Coatings on Large Substrates”, which describes the use of a modified LPPS system operated at high power and with chamber pressures well below the customary operating envelope. Since that time, others at Sulzer Metco and elsewhere have refined and extended the concept of operating at very low chamber pressures. Multiple new alternatives have been developed for using modified LPPS systems to rapidly deposit thin sprayed coatings from fine molten droplets or vapor deposited coatings from solid, liquid, or gas feedstock. The terminology for these new process technologies is not entirely consistent among various authors. In this paper, we adopt the following terminology: Plasma Spray—Thin Film (PS-TF) refers to a process with powder feedstock where deposition is predominantly by molten droplets, similar to conventional plasma spray, but at greatly reduced chamber pressures; Plasma Spray—Physical Vapor Deposition (PS-PVD) refers to a process in which powder feedstock is vaporized and deposition occurs primarily from the vapor phase; Plasma Spray—Chemical Vapor Deposition (PS-CVD) refers to a process that utilizes liquid or gas feedstock with deposition from the vapor phase; and Very Low Pressure Plasma Spray (VLPPS) will refer to the entire family of reduced pressure (<800 Pa (<6 Torr)) plasma spray technologies as just described.

3. Operating an LPPS System at Pressures Below 1.3 kPa (10 Torr)

The Low Pressure Plasma Spray System at Sandia National Laboratories (Figure 1) consists of a large (~3500 L; ~2m tall × ~1.5m dia.) water-cooled vacuum chamber manufactured by the former Electro-Plasma, Inc. of Irvine, California. A Sulzer Metco 03C plasma torch connected to a custom-built 2000A, 50V (open circuit) Halmar power supply is used for all spraying. Under normal operation, the plasma torch steadily introduces over 100 SLPM of process gas into the vacuum chamber. In order to maintain the chamber at the very low dynamic pressures needed for VLPPS operation, the original LPPS pumping system was augmented with a second, parallel, vacuum pumping system. Each vacuum pumping system consists of a roughing pump and a blower. One system is a Stokes model 615-1 blower backed by a Stokes 412-11 roughing pump. The other system is a Kinney KMBD1600-90L2 blower backed by a Kinney KT300 roughing pump. When operated simultaneously, these systems offer a total pumping capacity of ~82,000 SLPM (2900 CFM). This system allows steady-state operation at chamber pressures down to ~133 Pa (1 Torr). A custom-built five axis robotic system is integrated into the vacuum chamber and is used to manipulate the spray torch and/or the substrate. Feedstock delivery is accomplished using either a Brigs model 171D dry powder hopper or a custom built liquid suspension delivery system. All system control is accomplished through custom LabView™ software, which monitors and controls process inputs including: plasma gas flows and pressures, plasma current and voltage, chamber pressure, and plasma enthalpy (calculated from cooling water temperature rise). In addition, the vacuum chamber can be outfitted with an MKS residual gas analyzer, a FLIR infrared camera, and various thermocouples.
Torch stability and electrode wear are always a concern when operating a plasma torch at unusual conditions. In initial VLPPS operations at Sandia, very rapid degradation of the anode was experienced. Without modification, a standard BPC-353-113 anode deteriorated by melting and erosion of the arc chamber in times on the order of tens of minutes. It was necessary to modify the internal anode geometry in order to achieve an acceptable lifetime. The modified anode is shown in Figure 2. This modified anode geometry is based on the 03CA-97 anode with the diameter of the arc chamber increased to reduce the energy density in the arc chamber and improve water cooling efficiency. This modification resulted in significantly less arc chamber erosion and less local melting of the anode surface. The throat of this anode is designed for free expansion of the plasma at reduced pressures. A standard 12.7 mm (0.50 inch) diameter tungsten cathode (BPC-155-112) is used without modification.
A plot of voltage versus time for the modified anode is shown in Figure 3. Stable operation (+/- 2 volts) was achieved for 8 hours, even with multiple high frequency starts.

Recently, improved anodes (264, 270, 271) and an accompanying water cooling jacket have become available for the 03CA torch. These anodes are tungsten lined increasing the durability of the arc chamber and nozzle. In addition, they are configured so that water cooling near the front of the anode and around the powder injection ports is improved. Each of these anodes has a large arc chamber and a short nozzle. Experience at SNL has shown these anodes can be operated for well over 8 hours at VLPPS conditions.
4. Plasma Jet Properties at Very Low Chamber Pressures

Traditionally, LPPS systems are operated at chamber pressures on the order of 5 to 20 kPa (37 to 150 Torr). In contrast, VLPPS systems typically operate at chamber pressures on the order of 100 to 500 Pa (0.75 to 3.75 Torr). At these greatly reduced pressures, the plasma jet expands and lengthens significantly. Figure 4 compares plasma jets in the Sandia VLPPS system at pressures ranging from 760 Pa (5.7 Torr) down to 387 Pa (2.9 Torr). Even over this relatively modest pressure change, dramatic changes in the plasma jet are observed. The jet at the lowest pressure is more than 20 cm (~10 in) in diameter and extends to the base of the chamber, more than 1 m (3.3 ft) from the spray torch.

An experimental study of jet properties under the conditions of interest was conducted by Dorier et al. [2]. Their study involved a Sulzer Metco 03CP spray gun operating at 1500 A and 43 V with an H₂/Ar arc forming gas at flow rates of 3/100 SLPM. The pressure range investigated was 1 kPa to 200 Pa (7.5 to 1.5 Torr). These authors used a specially modified enthalpy probe and optical emission spectroscopy to investigate properties of the plasma jet under these very low pressure conditions. Dorier et al. measured the decrease in plasma jet density as the chamber pressure was decreased. For example, representative values estimated from their data plots at an axial distance of 800 mm from the nozzle exit indicate approximate jet densities of 6.5 × 10⁻⁴ kg/m³, 2.5 × 10⁻⁴ kg/m³, and 0.75 × 10⁻⁴ kg/m³ at 1000, 600, and 200 Pa (7.5, 4.5, and 1.5 Torr) chamber pressure respectively. These authors also reported increases in both jet velocity and jet temperature with decreasing chamber pressure. At the same 800 mm axial distance, their results indicate approximate jet velocities of 1000, 2500, and 3200 m/s with corresponding temperatures of 7500, 11,000, and 12,500 K at 1000, 600, and 200 Pa respectively. These
authors also conducted radial studies of jet properties and concluded that for very low pressures, on the order of 200 Pa, the temperature and velocity of the highly expanded jet are essentially constant up to 20 mm from the jet centerline. They attributed this to the low density of the surrounding chamber gas and laminar jet flow (Reynolds number ~100) resulting in weak interactions between the jet and the surrounding chamber atmosphere. They also noted that the collision rate at these chamber pressures is strongly reduced and, therefore, the assumption of local thermodynamic equilibrium may no longer be valid. Although the behavior of high energy density plasma at the pressures associated with VLPPS is not well understood, it has been reported that heat transfer is no longer collision dominated in these lower pressure regimes [2, 29-33].

**Figure 4.** Dramatic expansion of the plasma jet as pressure is reduced.

Complex interactions exist between the feedstock material and the VLPPS plasma, most of which can currently only be inferred based on plasma spray research at higher pressures [34-37]. If very fine powder (<15 microns) is injected into the plasma jet at very low pressures, the small particles tend to follow expansion of the jet and distribute across the plume. Considerable vaporization of the powder also occurs at high power levels. This is evident in Figure 5, where 5 micron copper powder injected into a VLPPS plasma jet produces an intense green emission from multiple spectral lines of copper vapor in the 505–530 nm wavelength range [1].
Figure 5. (a) VLPPS plasma jet expanding into a vacuum chamber held at ~133 Pa. (b) Injecting 5 micron Cu powder into the plasma jet produces intense green emission from copper vapor.

Figure 6. A generic phase diagram showing potential phase transformation pathways from initial feedstock entrainment into the plasma to deposition on a substrate.
5. Coating Examples (PS-PVD and PS-TF)

Sulzer-Metco has published a number of papers on the PS-TF process invented by Eric Muehlberger, originally referred to as Low Pressure Plasma Spray—Thin Film (LPPS-TF®) [3,4-8]. These papers clearly show that Yttria-Stabilized Zirconia (YSZ) coatings with highly columnar microstructures can be prepared using the LPPS-TF® process. This work also shows that process parameters significantly affect the density and morphology of the columnar microstructure. In addition, they show that both droplet and vapor deposition mechanisms can be used to prepare thin dense coatings. In the case of droplet deposition, thin dense coatings with a typical lamellar microstructure were demonstrated.

Sandia National Laboratories, in collaboration with The New Mexico Institute of Mining and Technology, has also published work on the preparation of YSZ using VLPPS [9]. The purpose of this work was to better understand the VLPPS YSZ coatings for application as solid-oxide fuel cell electrolytes. In the course of that work, the LPPS-TF® results reported by Refke et al. were confirmed [9]. Specifically, Sandia was able to confirm that the VLPPS process is capable of preparing thin dense coatings with lamellar microstructures indicative of liquid droplet deposition (Figure 7), as well as columnar microstructures (Figure 8) similar to those observed in vapor deposition processes, such as PVD or CVD. Notably, the 40 micron thick YSZ film shown in Figure 8, was prepared in less than 10 minutes of actual spray time. In addition, Sandia showed that VLPPS can be used to prepare coatings with microstructures that include both lamellar and columnar features, suggesting a mixed-mode deposition (Figure 9).

Figure 7. PS-TF Al2O3 coating prepared at Sandia using droplet deposition. A lamellar structure characteristic of liquid droplet deposition can be clearly seen.
Figure 8. PS-PVD YSZ coating prepared at Sandia. The coating is over 40 microns thick. Columnar structures similar to vapor deposited coatings can be clearly seen. For example Figure 1, Reference [10], shows similar columnar structure in a Electron Beam PVD YSZ coating.

Figure 9. VLPPS mixed-mode YSZ coating prepared at Sandia. The coating is over 100 microns thick. Lamellar structures characteristic of liquid droplet deposition and columnar structures (arrow) suggestive of vapor deposition can be clearly seen.

Mixed mode YSZ coatings were reported by Hospach *et al.* [11]. Vapor deposited copper coatings were reported by Zhang *et al.* [12]. Thin (<50µm) dense Mg-spinel (MgAl₂O₄) coatings deposited from droplets were reported by Mauer *et al.* [13]. Similarly Zhu *et al.* report thin dense lamellar YSZ coatings [14]. Many other authors have reported examples of PS-PVD coatings [1,6,7,9-13,15-17].
6. Other Feedstock Delivery Approaches

Feedstock delivery for VLPPS processes is not limited to dry powder. Successful operation has been demonstrated with liquid suspension, liquid precursors, and gaseous feedstocks. Sandia National Laboratories in collaboration with Purdue University has successfully deposited VLPPS coatings with a suspension feedstock delivery of Yttria Stabilized Zirconia particles suspended in ethanol [19]. Coating preparation from liquid precursors that chemically react in the plasma to form a coating have also been demonstrated. Specifically, silicon oxide films prepared from Hexamethyldisiloxane (HMDSO or C₁₈H₃₆OSi₂) are reported by Gindrat et al. and Dorier et al. [5,8]. In addition, both Gindrat and Dorier report the use of gaseous feedstocks. Gasses such as CH₄ and C₂H₄ were used to prepare amorphous carbon films [8]. Oxide coatings (Al₂O₃, ZnO, and SnO₂) were prepared by reacting evaporated metals with oxygen [5]. VLPPS using reactive liquid or gaseous feedstocks is termed PS-CVD.

7. New Applications and Opportunities for VLPPS

There are many promising applications of VLPPS processes. Primary among them are thermal barrier coatings and solid oxide fuel cells (SOFC). PS-PVD YSZ coatings have microstructures very similar to EB-PVD (electron beam physical vapor deposition), which have a long history of success as thermal barrier coatings. However, the PS-PVD process has the advantages of faster deposition rates, larger spray patterns, and non line-of-sight deposition [1,6,7,9,11,13,15-18].

Plasma spray technologies are already in use for solid oxide fuel cell (SOFC) preparation, but VLPPS has the potential for dramatic improvement over traditional plasma spray [9,15,19-25]. Firstly, the VLPPS system provides dynamic control over the ambient chamber pressure during processing. Thus, entire fuel cell systems can be constructed with measured or graded porosities to optimize each component in the cell [20-23,25]. In addition, the VLPPS process’s ability to create thin and dense coatings makes it better suited than traditional thermal spray processes towards meeting the design criteria for SOFC electrolytes [9,15,19,20,22]. Furthermore, the columnar structure offers the potential for shorter ion diffusion paths through the electrolyte compared to a lamellar structure. If this could be realized, it would represent an improvement in electrolyte performance.

There are many other untried applications for VLPPS coatings. Among these applications are photocatalytic coatings, wear-resistant coatings, and coatings for biomedical applications [26,27]. To date, the vast majority of work has focused on ceramic coatings, particularly YSZ. Isolated instances of metal coatings have been reported [12]. Figure 10 shows a nickel coating prepared using the PS-TF process at Sandia. The exploration of VLPPS metal coatings could lead to a multitude of other applications, such as replacements for electroplated coatings and wear resistant metal-ceramic composite coatings.
Figure 10. Micrograph showing the cross section of a nickel coating produced using PS-TF process in the VLPPS system at Sandia National Laboratories. This coating exhibits the familiar lamellar microstructure of a conventional plasma spray coating, but it is fully dense and less than 100 microns in thickness.

8. Open Questions—Needed Additional Research

The work discussed above has clearly demonstrated that VLPPS processes can be used to prepare thin (1 < t < 100µm), dense coatings with unique microstructures. Like most thermal spray processes, a wide range of metal, ceramic, and composite feedstocks can be deposited. However, an improved understanding of the VLPPS family of processes would foster more rapid adoption by the thermal spray community. Specific questions yet to be answered include a better understanding of the properties and physics of the plasma jet at greatly reduced chamber pressures, interactions between the plasma and the feedstock, phase transformation pathways for the feedstock, and the mechanism(s) responsible for columnar microstructures.

9. Summary

The VLPPS process allows rapid preparation of thin (1 < t < 100 micron), dense coatings. Microstructures characteristic of both droplet deposition and vapor deposition have been reported by Sulzer-Metco and confirmed by Sandia National Laboratories [3,9]. Deposition rates associated with VLPPS are considerably faster than traditional thin film processes such as PVD and CVD. VLPPS offers the opportunity to bridge the thickness gap between traditional thermal spray and thin film coating processes. In addition, VLPPS offers the ability to create columnar and mixed mode microstructures. Mixed mode deposition is not normally encountered in either thermal spray or PVD/CVD processes. Mixed mode deposition offers the potential to prepare coatings that have properties associated with both vapor deposited microstructures (e.g., strain tolerance due to columnar grain structure) and droplet deposited microstructures (e.g., rapid build rates).

The VLPPS process, by accessing new regions of parameter space, should enable a variety of new coating applications. Current work is focused on thermal barrier coatings and SOFC electrolytes; however, one can envision many other opportunities for VLPPS ceramic, metal, and composite coatings.
Like most emerging processes, significant gaps currently exist in our understanding of the VLPPS family of processes. These areas include: particle-plasma interactions in the rarefied plasma, particle vaporization and its affect on plasma properties, and deposition mechanisms associated with columnar microstructures. Increased understanding in each of these areas will enable the spray community to more readily apply VLPPS processes to meet emerging coating challenges.

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References


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